

DATE: May 2, 2017

PCN #: 2263

PCN Title: Bill of Material (BOM) Changes for Select Analog Parts

Dear Customer:

This is an announcement of change(s) to products that are currently being offered by Diodes Incorporated.

We request that you acknowledge receipt of this notification within 30 days of the date of this PCN. If you require samples for evaluation purposes, please make a request within 30 days as well. Otherwise, samples may not be built prior to this change. Please refer to the implementation date of this change as it is stated in the attached PCN form. Please contact your local Diodes sales representative to acknowledge receipt of this PCN and for any sample requests.

The changes announced in this PCN will not be implemented earlier than 90 days from the notification date stated in the attached PCN form.

Previously agreed upon customer specific change process requirements or device specific requirements will be addressed separately.

For questions or clarification regarding this PCN, please contact your local Diodes sales representative.

Sincerely,

Diodes Incorporated PCN Team



PRODUCT CHANGE NOTICE

PCN-2263 REV 00

This PCN is being issued to 1) In order to improve 74LVC1T45Z6-7 (L 2) In order to improve for select AL1676x	D notify customers that: product manufactural eadframe), Output Open/Short P series controllers, and continuity of supply, I u wire bond)	bility, Diodes Incorporated ha Protection (OVP), Diodes Inco d Diodes Incorporated has qua	s qualified an additional BC rporated has qualified an ad ified an additional BOM for	dditional die design select SPx / XRPx		
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specifications exist.	on and reliability testing	g have been completed to er	sure that no changes in dat	ta sheet electrical		
Please see Tables 1 – 3 for a						
Please see Tables 1 – 3 for a		PRODUCTS AFFECTED				
Table 1: Qualify Additional BC						
Table 2: Qualify Additional Die	U					
Table 3: Qualify Additional BC	OM (Copper Bond Wire))				
		WEB LINKS				
Ianufacturer's Notice: http://www.diodes.com/pcns						
For More Information Cont	More Information Contact: http://www.diodes.com/contacts.html					
Data Sheet:	http://ww	w.diodes.com/catalog				
		DISCLAIMER				



Table 1: Qualify Additional BOM (Leadframe)

74LVC1T45Z6-7

Table 2: Qualify Additional Die DesignAL1676-30AS7-13AL1676-40DS7-13

Table 3: Qualify Additional BOM (Copper Bond Wire)						
SP34063AEN-L/TR	SPX431AM1-L/TR	SPX431AN-L/TR	XRP431LES5TRR3-F	XRP7659ISTR-F		